	Application No.	Applicant(s)	٦
	10/713,762	CHENG, YANG CHIN	
Notice of Allowability	Examiner	Art Unit	\dashv
	Thanhha Dham	2813	
	Thanhha Pham	2010	4
The MAILING DATE of this communication appearable claims being allowable, PROSECUTION ON THE MERITS IS (nerewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHT of the Office or upon petition by the applicant. See 37 CFR 1.313	OR REMAINS) CLOSED in this apport of the communication GHTS. This application is subject to	plication. If not included not included not included the mailed in due course. THIS	
1. This communication is responsive to <u>3/14/2007</u> .	•		Ì
2. X The allowed claim(s) is/are <u>1,2,8-12,17-19,21-24 and 27-29</u>	2.		
 Acknowledgment is made of a claim for foreign priority units a) ☐ All b) ☐ Some* c) ☐ None of the: 			
1. Certified copies of the priority documents have			
2. Certified copies of the priority documents have			
3. Copies of the certified copies of the priority doc	cuments have been received in this	national stage application from the	
International Bureau (PCT Rule 17.2(a)).			
* Certified copies not received:			
Applicant has THREE MONTHS FROM THE "MAILING DATE" of noted below. Failure to timely comply will result in ABANDONM THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.	of this communication to file a reply ENT of this application.	complying with the requirements	
4. A SUBSTITUTE OATH OR DECLARATION must be submi INFORMAL PATENT APPLICATION (PTO-152) which give			
5. CORRECTED DRAWINGS (as "replacement sheets") mus	t be submitted.		
(a) including changes required by the Notice of Draftspers	on's Patent Drawing Review (PTO-	-948) attached	
1) 🗌 hereto or 2) 🔲 to Paper No./Mail Date			
(b) ☐ including changes required by the attached Examiner's Paper No./Mail Date			
Identifying indicia such as the application number (see 37 CFR 1. each sheet. Replacement sheet(s) should be labeled as such in the	.84(c)) should be written on the drawi ne header according to 37 CFR 1.121(ings in the front (not the back) of (d).	
 DEPOSIT OF and/or INFORMATION about the deposit attached Examiner's comment regarding REQUIREMENT I 	sit of BIOLOGICAL MATERIAL (FOR THE DEPOSIT OF BIOLOGIC	must be submitted. Note the AL MATERIAL.	
Attachment(s)			
1. Notice of References Cited (PTO-892)	5. Notice of Informal F	Patent Application	
2. Notice of Draftperson's Patent Drawing Review (PTO-948)	6. ☐ Interview Summary Paper No./Mail Da		
3. Information Disclosure Statements (PTO/SB/08),	7. Maper No./Mail Da 7. Examiner's Amend		
Paper No./Mail Date 4. Examiner's Comment Regarding Requirement for Deposit	. 8. 🛛 Examiner's Statem	ent of Reasons for Allowance	
of Biological Material	9. Other		
	THAN PRIMA	HHAS. PHAM ARY EXAMINER 3/22/6	2
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DETAILED ACTION

This Office Action is in response to Applicant's Amendment dated 3/14/2007.

Allowable Subject Matter

- 1. Claims 1-2, 8-12, 17-19, 21-24, 27-29 are allowed.
- 2. The following is an examiner's statement of reasons for allowance:
- Recorded Prior Art fails to disclose or suggest the combination of the process steps for forming a semiconductor device as recited in the base claim 1 comprising: performing an ultraviolet radiation exposure to reduce a cross-linked polymer state of the separate photoresist structures; forming a protectant layer over the separate photoresist structures using a diffusion sylilation process; removing a portion of the protectant layer to expose an underlying portion of the photoresist layer; removing the photoresist layer to form at least part of the protectant layer into separate protectant structures having second distances between corresponding points of the separate protectant structures defining a second pitch, the second pitch being less than the first pitch; and removing a portion of the material layer using the separate protectant structures as a mask.
- Recorded Prior Art fails to disclose or suggest the combination of the process steps as recited in the base claim 17 comprising: performing a treatment on the second layer to form at least part of the second layer into separate structures having first distances between corresponding points of the separate structure defining a first pitch,

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reducing a cross-linked polymer state of the separate structures using ultraviolet radiation, and performing silylation to form a protection layer over the separate structures; removing a first portion of the protection layer to expose the separate structures; removing the separate structures to form at least part of the protection layer into separate protection structure having second distances between corresponding points of the separate protection structures defining a second pitch less than the first pitch; and using the separate protection structures as an etch mask, removing an exposed portion of the first layer.

Recorded Prior Art fails to disclose or suggest the combination of the process steps for forming a semiconductor device having a reduced pitch as recited in the base claim 27 comprising: exposing the patterned photoresist layer to ultraviolet radiation to alter at least one property of the patterned photoresist layer so that a cross-link degree of a portion of the patterned photoresist layer is reduced; silylanzing the patterned photoresist layer in a gas phase or a liquid phase by diffusing silylamine into the patterned photoresist layer and forming a silylated layer over the surface; removing a first portion of the silylated layer to expose the patterned photoresist layer using an etching back process or a chemical mechanical planarization process; removing the patterned photoresist layer using a plasma gas to form at least part of the silylated layer into separate silylated structures having second distances between corresponding points of the separate silylated structures defining a second pitch, the second pitch being less than the first pitch; and using the separate silylated structures as an etch mask, removing an exposed portion of the material layer.

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3. Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanhha Pham whose telephone number is (571) 272-1696. The examiner can normally be reached on Monday and Thursday 9:00AM - 9:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead can be reached on (571) 272-1702. The fax phone number for the organization where this application or proceeding is assigned is 571-272-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

TSP

THANHHA S. PHAM PRIMARY EXAMINER